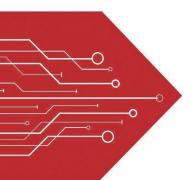
# MSKSEMI















**ESD** 

**TVS** 

**TSS** 

MOV

**GDT** 

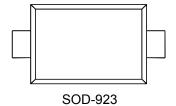
**PLED** 

Product data sheet

www.msksemi.com



- ♦ Low current rectification
- ♦ Low forward voltage
- ♦ SOD-923 Micro SMD package( Fig-)1 Dimensions: 1.0 mm x 0.6 mm (0.039" x 0.024")
- ♦ RoHS compliant
- ♦ UL-94 V-0 / Green EMC
- ♦ Matte Tin Lead finish (Pb-Free)
- ♦ Cathode Band / Device marking:



Absolute Maximum Ratings (Ta = 25 ℃)

Symbol	Parameter	Value	Units
$V_{RRM}$	Repetitive Peak Reverse Voltage	30	٧
$V_{R}$	Reverse Voltage	30	٧
$I_{O}$	Continuous Forward Current	100	mA
$\mathbf{I}_{FSM}$	Non-Repetitive Peak Forward Current *1	500	mA
TJ	Junction Temperature	125	°C
T <sub>STG</sub>	Storage Temperature	−55 to +125	°C

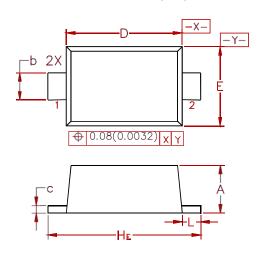
<sup>\*1: 8.3</sup>ms Single Half Sine-Wave

#### Electrical Characteristics (Ta = 25 ℃)

Symbol	Parameter	Conditions	Min	TYP	Max	Units	
$V_{F}$	Forward Voltage	I <sub>F</sub> = 10mA			0.35	V	
		I <sub>F</sub> = 20mA			0.40	V	
BV <sub>R</sub>	Breakdown Voltage	I <sub>R</sub> = 100 μ A	30			٧	
$I_{R}$	Reverse Current	V <sub>R</sub> = 10V			10	μΑ	
		V <sub>R</sub> = 30V			50	μΑ	

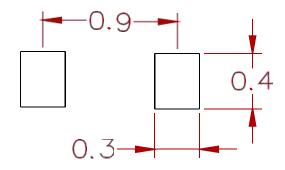


#### **PACKAGE MECHANICAL DATA**



Dim		Millimeters			Inches	
	Min	Nom	Max	Min	Nom	Max
Α	0.36	0.40	0.43	0.014	0.016	0.017
b	0.15	0.20	0.25	0.006	0.008	0.010
С	0.07	0.12	0.17	0.003	0.005	0.007
D	0.75	0.80	0.85	0.030	0.031	0.033
E	0.55	0.60	0.65	0.022	0.024	0.026
HE	0.95	1.00	1.05	0.037	0.039	0.041
L	0.05	0.10	0.15	0.002	0.004	0.006

## **Suggested Pad Layout**



**Dimensions: Millimeters** 

#### **REEL SPECIFICATION**

P/N	PKG	QTY
CDB0130QRM-MS	SOD-923	3000

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